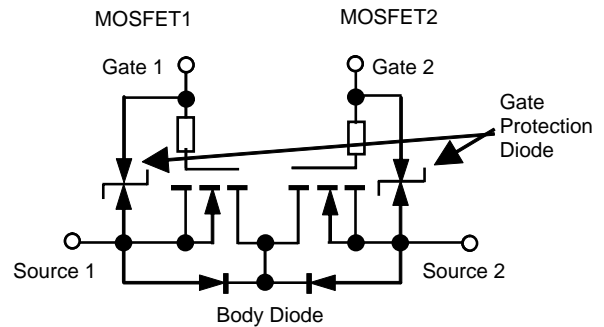
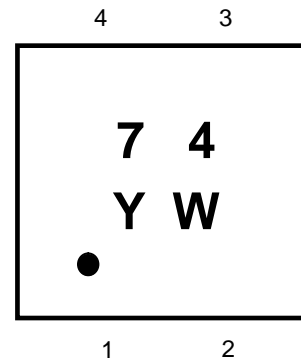


**WNMD2174**
**Dual N-Channel, 12V, 6A, Power MOSFET**
[www.sh-willsemi.com](http://www.sh-willsemi.com)

| V <sub>SSS</sub> (V) | Typ R <sub>SS(on)</sub> (mΩ) |
|----------------------|------------------------------|
| 12                   | 19@ V <sub>GS</sub> =4.5V    |
|                      | 20@ V <sub>GS</sub> =4.0V    |
|                      | 21@ V <sub>GS</sub> =3.8V    |
|                      | 22@ V <sub>GS</sub> =3.1V    |
|                      | 25@ V <sub>GS</sub> =2.5V    |
| ESD Rating:2000V HBM |                              |


**Descriptions**

The WNMD2174 is Dual N-Channel enhancement MOS Field Effect Transistor and connecting the Drains on the circuit board is not required because the Drains of the MOSFET1 and the MOSFET2 are internally connected. Uses advanced trench technology and design to provide excellent R<sub>SS(ON)</sub> with low gate charge. This device is designed for Lithium-Ion battery protection circuit. The WNMD2174 is available in CSP 4L package. Standard Product WNMD2174 is Pb-free and Halogen-free.

**CSP 4L**


- 1: Source 1      74 = Device Code
- 2: Gate 1        Y = Year
- 3: Gate 2        W = Week (A~z)
- 4: Source 2

**Features**

- Trench Technology
- Supper high density cell design
- Excellent ON resistance for higher DC current
- Extremely Low Threshold Voltage
- Small package CSP 4L

**Pin configuration (TOP view)&Marking**
**Order information**

| Device        | Package | Shipping       |
|---------------|---------|----------------|
| WNMD2174-4/TR | CSP 4L  | 3000/Reel&Tape |

**Applications**

- Lithium-Ion battery protection circuit

**Electronics Characteristics (Ta=25°C, unless otherwise noted)**

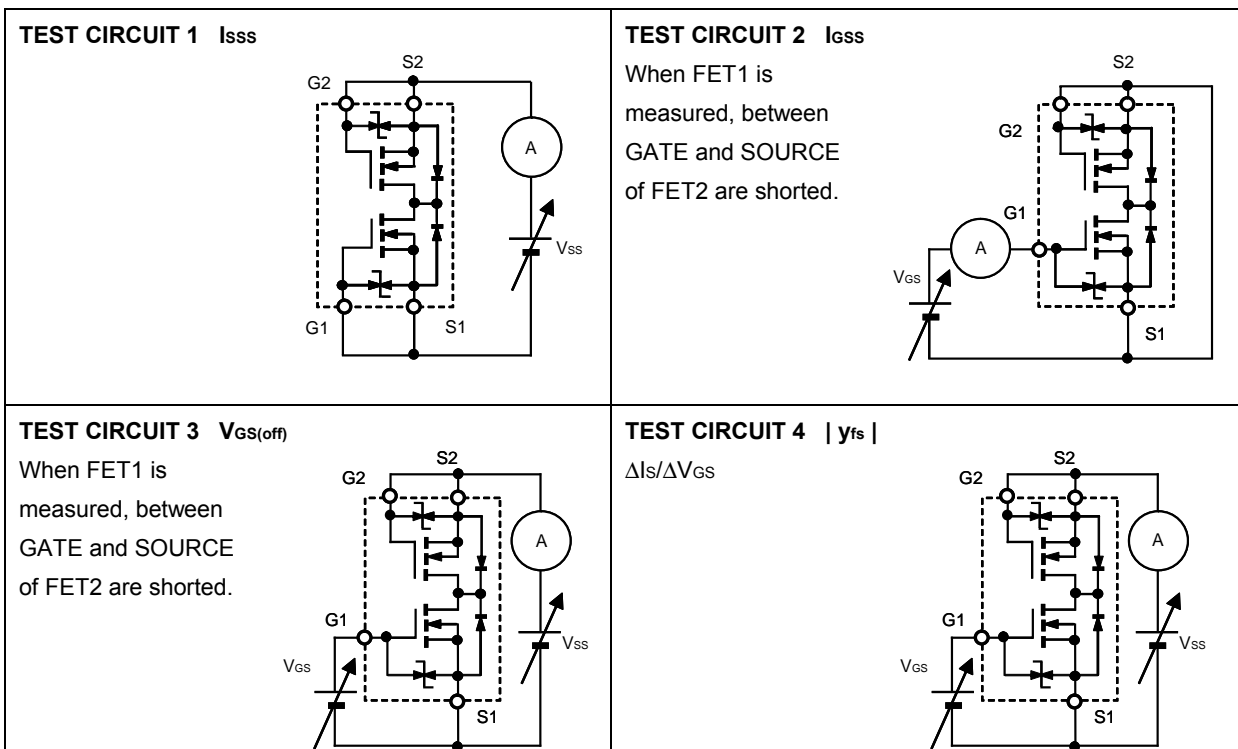
| Parameter  | Symbol               | Test Conditions   | Min  | Typ  | Max | Unit |
|--|----------------------|---|------|------|-----|------|
| <b>OFF CHARACTERISTICS</b>                       |                      |   |      |      |     |      |
| Source to Source Voltage                         | V <sub>SSS</sub>     | V <sub>GS</sub> = 0 V, I <sub>S</sub> = 250uA   | 12   |      |     | V    |
| Zero Gate Voltage Drain Current                  | I <sub>SSS</sub>     | V <sub>SS</sub> = 12 V, V <sub>GS</sub> = 0V<br>TEST CIRCUIT 1  |      |      | 1   | uA   |
| Gate Leakage Current                             | I <sub>GSS</sub>     | V <sub>SS</sub> = 0 V, V <sub>GS</sub> = ±10V<br>TEST CIRCUIT 2   |      |      | ±10 | uA   |
| <b>ON CHARACTERISTICS</b>                        |                      |   |      |      |     |      |
| Gate to Source Cut-off Voltage                   | V <sub>GS(off)</sub> | V <sub>GS</sub> = V <sub>SS</sub> , I <sub>S</sub> = 250uA<br>TEST CIRCUIT 3  | 0.4  | 0.8  | 1.2 | V    |
| Source to Source On-state Resistance             | R <sub>SS(on)</sub>  | V <sub>GS</sub> = 4.5V, I <sub>S</sub> = 3.0A<br>TEST CIRCUIT 5   | 10   | 19   | 25  | mΩ   |
|  |                      | V <sub>GS</sub> = 4.0V, I <sub>S</sub> = 3.0A<br>TEST CIRCUIT 5   | 11   | 20   | 27  |      |
|  |                      | V <sub>GS</sub> = 3.8V, I <sub>S</sub> = 3.0A<br>TEST CIRCUIT 5   | 11.5 | 21   | 28  |      |
|  |                      | V <sub>GS</sub> = 3.1V, I <sub>S</sub> = 3.0A<br>TEST CIRCUIT 5   | 12   | 22   | 31  |      |
|  |                      | V <sub>GS</sub> = 2.5V, I <sub>S</sub> = 3.0A<br>TEST CIRCUIT 5   | 14   | 25   | 35  |      |
| Forward Transfer Admittance                      | y <sub>fs</sub>      | V <sub>SS</sub> = 10 V, I <sub>S</sub> = 1.8A<br>TEST CIRCUIT 4   |      | 9    |     | S    |
| <b>BODY DIODE CHARACTERISTICS</b>                |                      |   |      |      |     |      |
| Body Diode Forward Voltage                       | V <sub>F(S-S)</sub>  | V <sub>GS</sub> = 0 V, I <sub>F</sub> = 1.0A<br>TEST CIRCUIT 6  |      | 0.9  | 1.5 | V    |
| <b>SWITCHING CHARACTERISTICS</b>                 |                      |   |      |      |     |      |
| Turn-On Delay Time                               | td(ON)               | V <sub>GS</sub> = 4.5 V, V <sub>SS</sub> = 10V,<br>R <sub>L</sub> = 3.3 Ω, I <sub>S</sub> = 3A, R <sub>G</sub> = 6Ω<br>TEST CIRCUIT 8 |      | 680  |     | ns   |
| Rise Time  | tr                   |   |      | 2960 |     |      |
| Turn-Off Delay Time                              | td(OFF)              |   |      | 6480 |     |      |
| Fall Time  | tf                   |   |      | 6760 |     |      |
| <b>CHARGES, CAPACITANCES AND GATE RESISTANCE</b> |                      |   |      |      |     |      |
| Input Capacitance                                | C <sub>ISS</sub>     | V <sub>GS</sub> = 0 V, f = 1kHz,<br>V <sub>SS</sub> = 10 V<br>TEST CIRCUIT 7  |      | 1313 |     | pF   |
| Output Capacitance                               | C <sub>OSS</sub>     |   |      | 257  |     |      |
| Reverse Transfer Capacitance                     | C <sub>RSS</sub>     |   |      | 238  |     |      |
| Total Gate Charge                                | Q <sub>G(TOT)</sub>  | V <sub>G1S1</sub> = 4.5 V, V <sub>SS</sub> = 10V,<br>I <sub>S</sub> = 6A<br>TEST CIRCUIT 9  |      | 17.8 |     | nC   |
| Threshold Gate Charge                            | Q <sub>G(TH)</sub>   |   |      | 0.79 |     |      |
| Gate-to-Source Charge                            | Q <sub>GS</sub>      |   |      | 2.5  |     |      |
| Gate-to-Drain Charge                             | Q <sub>GD</sub>      |   |      | 6.4  |     |      |

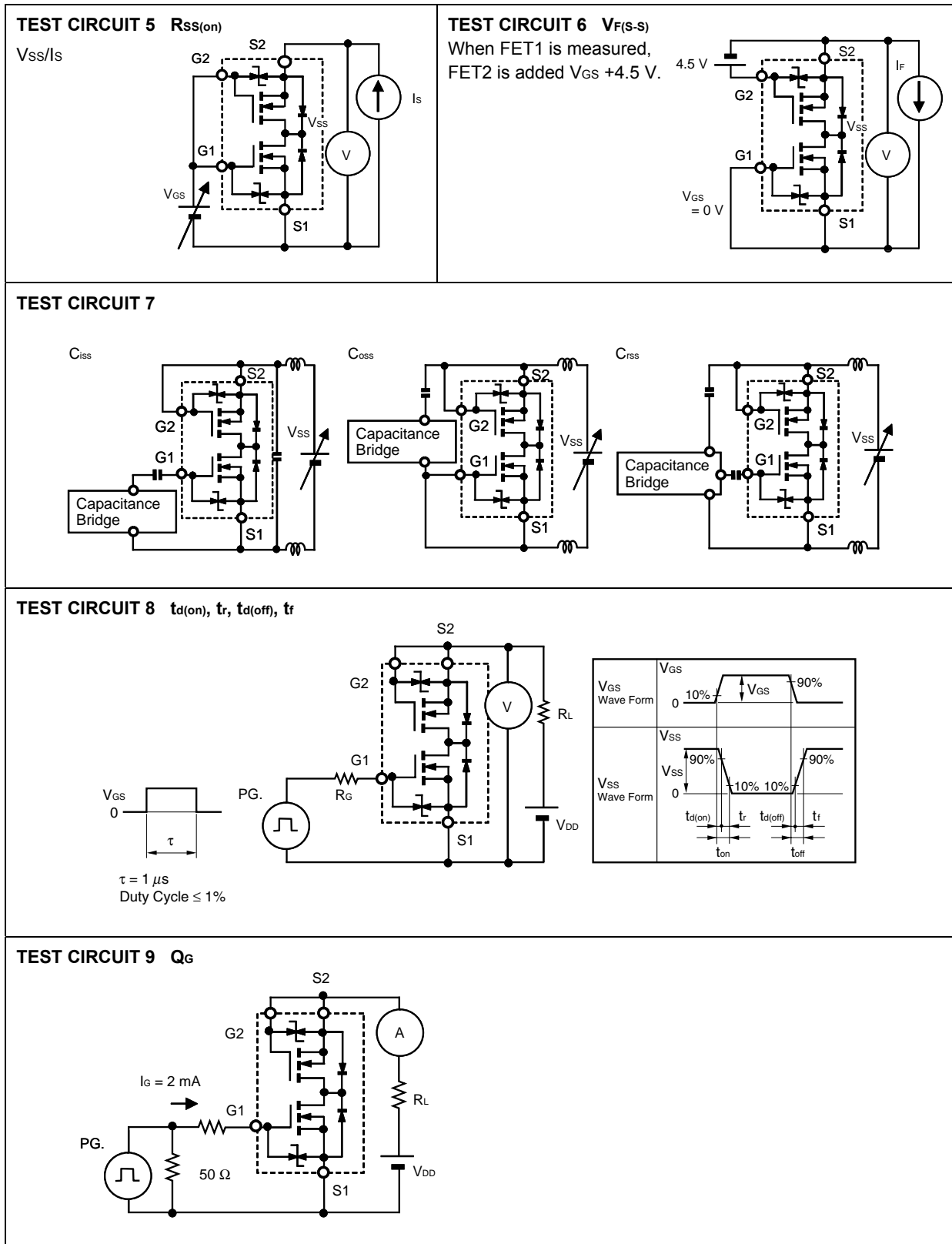
**Absolute Maximum ratings**

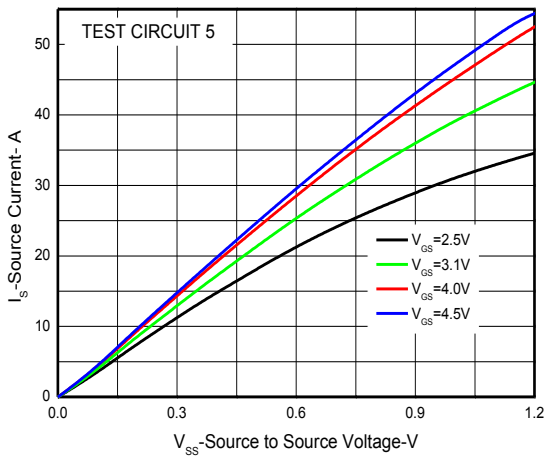
| Parameter  | Symbol                | 10 s       | Steady State       | Unit               |
|--|-----------------------|------------|--------------------|--------------------|
| Source to Source Voltage ( $V_{GS} = 0\text{ V}$ ) | $V_{SSS}$             | 12         | V                  | V                  |
| Gate to Source Voltage ( $V_{SS} = 0\text{ V}$ )   | $V_{GSS}$             | $\pm 10$   |                    |                    |
| Source Current (pulse) <sup>Note.c</sup>           | $I_{S(\text{pulse})}$ | 60         | A                  | A                  |
| Source Current (DC)                                | $I_S$                 | 6          | A                  | A                  |
| Channel Temperature                                | $T_{ch}$              | 150        | $^{\circ}\text{C}$ | $^{\circ}\text{C}$ |
| Storage Temperature Range                          | $T_{stg}$             | -55 to 150 | $^{\circ}\text{C}$ | $^{\circ}\text{C}$ |

Note.c  $PW \leq 10\mu\text{s}$ , duty cycle  $\leq 1\%$ ;

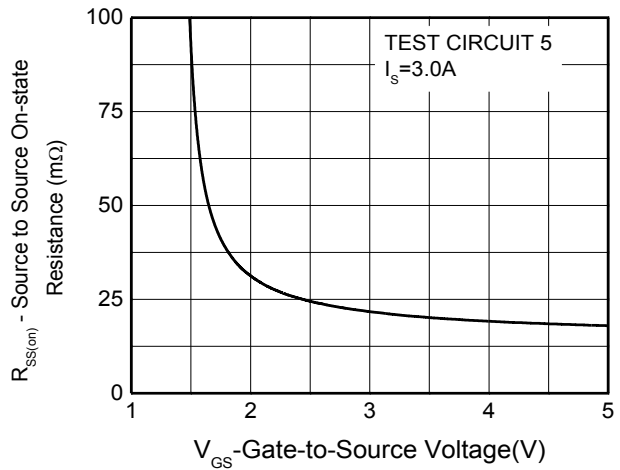
Both the FET1 and the FET2 are measured. Test circuits are example of measuring the FET1 side.



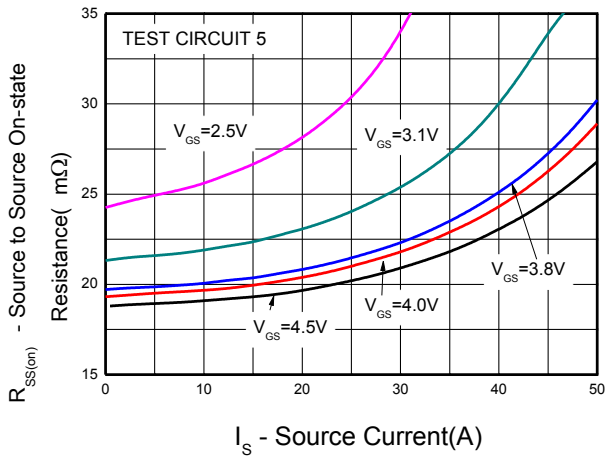


**Typical Characteristics (Ta=25°C, unless otherwise noted)**


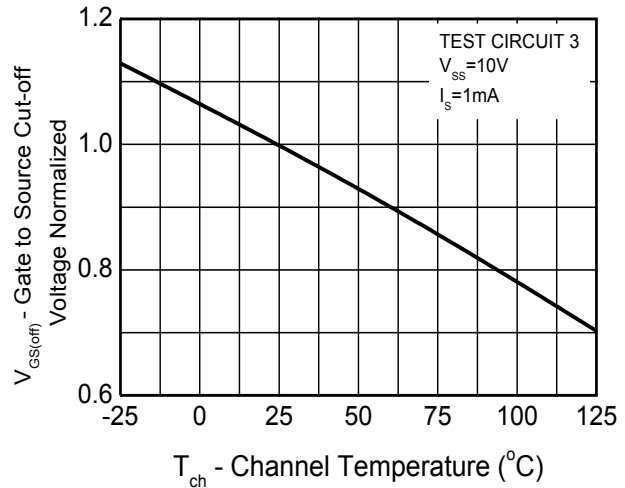
**SOURCE CURRENT vs.  
SOURCE TO SOURCE VOLTAGE**



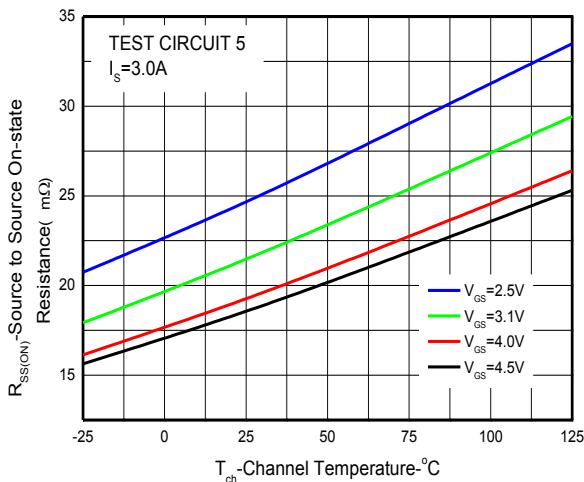
**SOURCE TO SOURCE ON-STATE RESISTANCE vs.  
GATE TO SOURCE VOLTAGE**



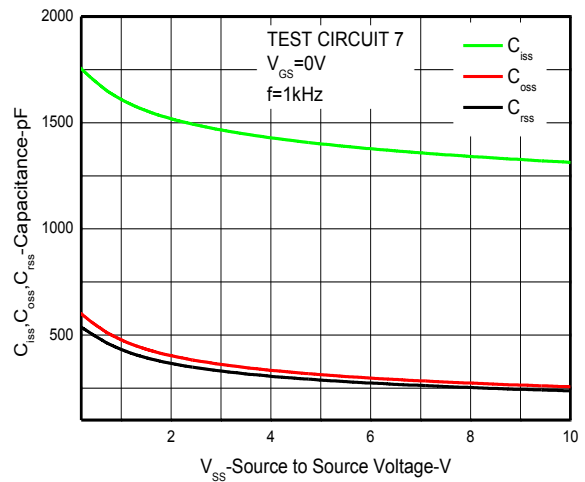
**SOURCE TO SOURCE ON-STATE RESISTANCE vs.  
SOURCE CURRENT**



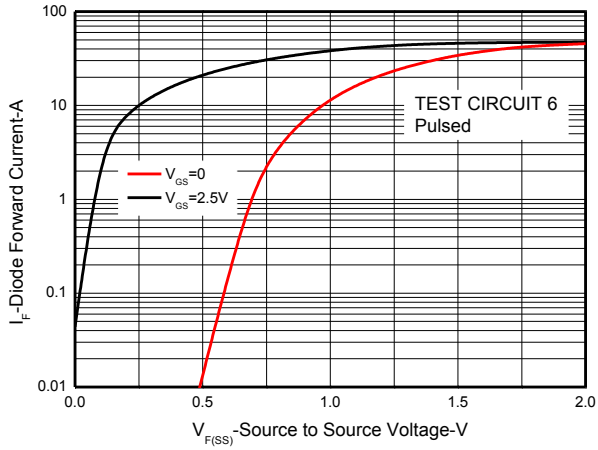
**GATE TO SOURCE CUT-OFF VOLTAGE vs.  
CHANNEL TEMPERATURE**



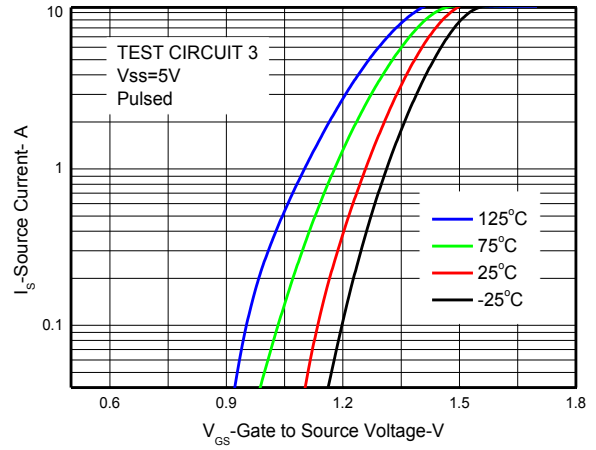
**SOURCE TO SOURCE ON-STATE RESISTANCE vs.  
CHANNEL TEMPERATURE**



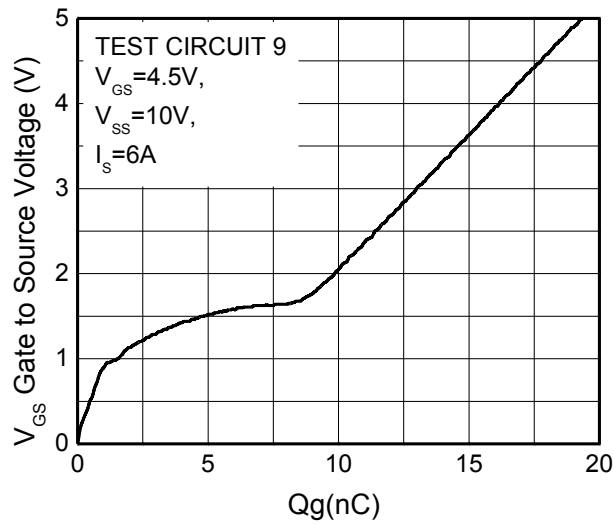
**CAPACITANCE vs. SOURCE TO SOURCE VOLTAGE**



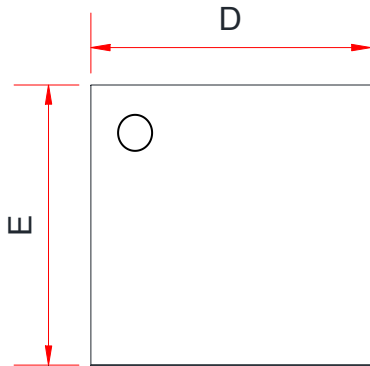
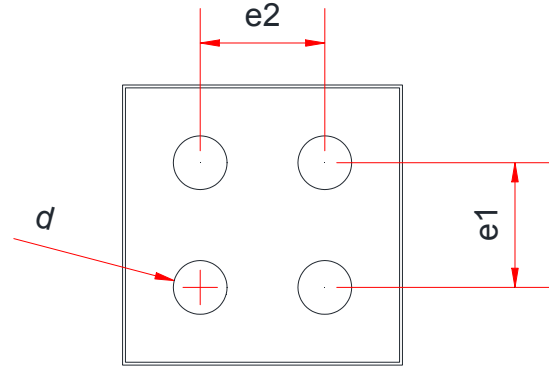
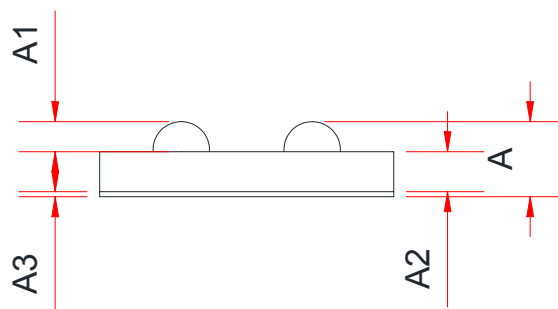
SOURCE TO SOURCE DIODE FORWARD VOLTAGE



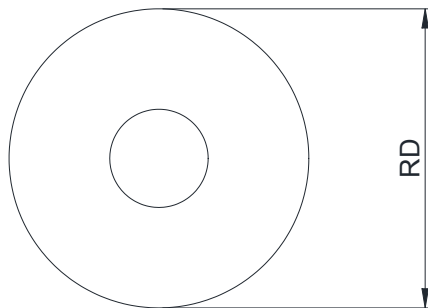
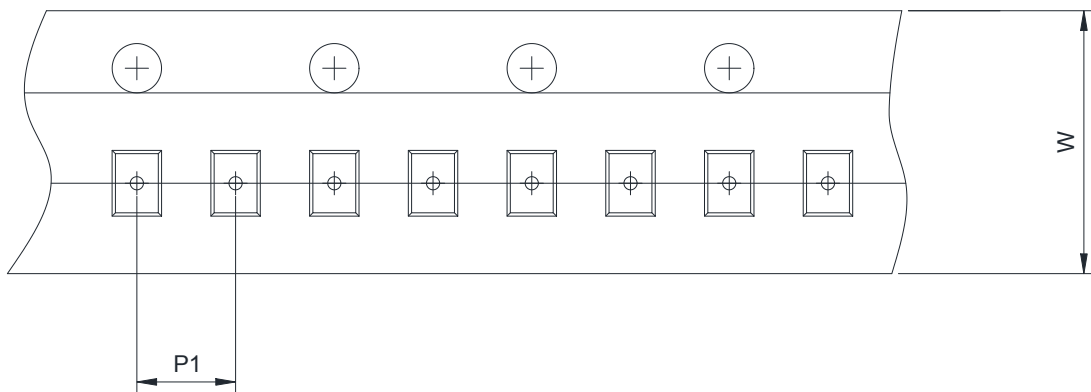
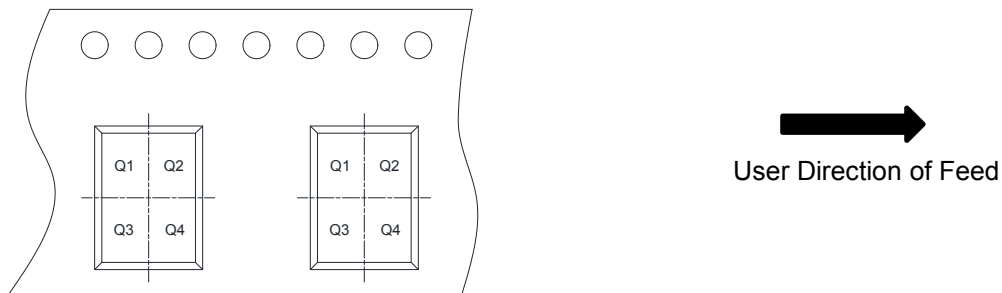
FORWARD TRANSFER CHARACTERISTICS



DYNAMIC INPUT CHARACTERISTICS

**Package outline dimensions (Unit:um )**
**CSP-4L**

**TOP VIEW**

**BOTTOM VIEW**

**SIDE VIEW**

| Symbol | Dimensions in Millimeters |      |       |
|--------|---------------------------|------|-------|
|        | Min.                      | Typ. | Max.  |
| A      | 0.33                      | 0.37 | 0.42  |
| A1     | 0.13                      | 0.15 | 0.17  |
| A2     | 0.18                      | 0.20 | 0.22  |
| A3     | 0.02                      | —    | 0.030 |
| D      | 1.43                      | 1.46 | 1.49  |
| E      | 1.43                      | 1.46 | 1.49  |
| e1     | 0.65 Typ.                 |      |       |
| e2     | 0.65 Typ.                 |      |       |
| d      | 0.26                      | 0.28 | 0.30  |

**TAPE AND REEL INFORMATION**
**Reel Dimensions**

**Tape Dimensions**

**Quadrant Assignments For PIN1 Orientation In Tape**


|      |   |   |   |
|------|---|---|---|
| RD   | Reel Dimension                          | <input checked="" type="checkbox"/> 7inch | <input type="checkbox"/> 13inch   |
| W    | Overall width of the carrier tape       | <input checked="" type="checkbox"/> 8mm   | <input type="checkbox"/> 12mm <input type="checkbox"/> 16mm                         |
| P1   | Pitch between successive cavity centers | <input type="checkbox"/> 2mm              | <input checked="" type="checkbox"/> 4mm <input type="checkbox"/> 8mm                |
| Pin1 | Pin1 Quadrant                           | <input checked="" type="checkbox"/> Q1    | <input type="checkbox"/> Q2 <input type="checkbox"/> Q3 <input type="checkbox"/> Q4 |